Written by Frederick Douglas 06 February 2019

Taiwanese memory maker G.Skill announces the Trident Z Royal DDR4 RGB memory kits, designed for use with the latest unlocked 28-core Intel Xeon W-3175X processor operating in hexa-channel with 6- or 12-module kit configurations.



The 6-channel memory kits promise XMP 2.0 supported speeds of up to DDR4-4000 CL17-18-18-38 at 1.35V, thanks to Samsung B-die memory ICs. They range in rated frequency from 3200 to 4000MHz, and in size from 4GB (8GB x6) to 192GB (16GB x12). According to the company, the DDR4-4000 CL17 96GB (8GBx12) kit offers real bandwidth of 122GB/s, a "substantial incease" compared to currently available quad-channel platforms.

G.Skill says it tested the Trident Z Royal DDR4 RGB kits on Asus ROG Dominus Extreme motherboards, as equipped with the appropriate Xeon W-3175X processors. The memory kits should be shipping now.

Go G.Skill Announces New Hexa-Channel Massive Capacity DDR4 Memory Kits